

## Features

- N-Channel Switch with Low  $R_{DS(ON)}$
- Operated at Low Logic Level Gate Drive
- Epoxy Meets UL 94 V-0 Flammability Rating
- Moisture Sensitivity Level 1
- Halogen Free. "Green" Device (Note 1)
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

## N-Channel MOSFET

## Maximum Ratings

- Operating Junction Temperature Range: -55°C to +150°C
- Storage Temperature Range: -55°C to +150°C
- Maximum Thermal Resistance: 625°C/W Junction to Ambient

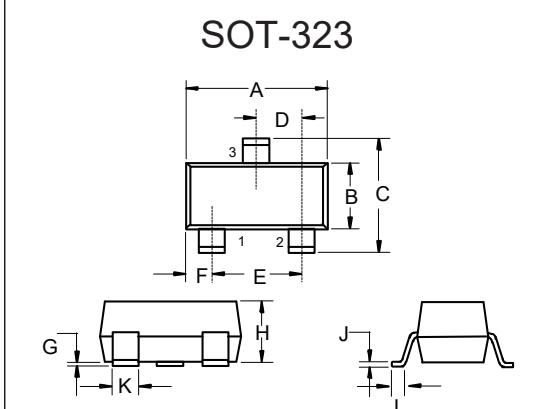
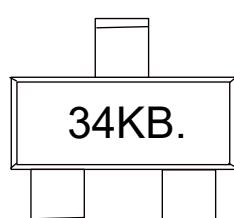
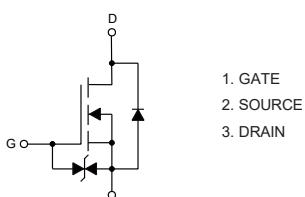
Parameter	Symbol	Rating	Unit
Drain -source Voltage	$V_{DS}$	20	V
Gate -Source Voltage	$V_{GS}$	$\pm 12$	V
Drain Current-Continuous	$I_D$	0.75	A
Pulsed Drain Current <sup>(Note 2)</sup>	$I_{DM}$	3.0	A
Power Dissipation <sup>(Note 3)</sup>	$P_D$	0.2	W

Note: 1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

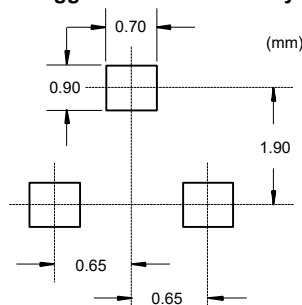
3. This test is performed with no heat sink at  $T_a=25^\circ C$ .

## Internal Structure and Marking Code



DIM	INCHES		MM		NOTE
	MIN	MAX	MIN	MAX	
A	0.071	0.087	1.80	2.20	
B	0.045	0.053	1.15	1.35	
C	0.083	0.096	2.10	2.45	
D	0.026		0.65		TYP.
E	0.047	0.055	1.20	1.40	
F	0.012	0.016	0.30	0.40	
G	0.000	0.004	0.00	0.10	
H	0.035	0.044	0.90	1.10	
J	0.002	0.010	0.05	0.25	
K	0.006	0.016	0.15	0.40	
L	0.010	0.018	0.26	0.46	

### Suggested Solder Pad Layout



**ELECTRICAL CHARACTERISTICS (Ta=25°C unless otherwise specified)**

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
<b>Static Characteristics</b>						
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	20			V
Gate-Source Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> =0V, V <sub>GS</sub> =±10V			±10	μA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =20V, V <sub>GS</sub> =0V			1	μA
Gate-Threshold Voltage <sup>(Note4)</sup>	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	0.5	0.7	1.1	V
Drain-Source On-Resistance <sup>(Note4)</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> =4.5V, I <sub>D</sub> =500mA			300	mΩ
		V <sub>GS</sub> =2.5V, I <sub>D</sub> =400mA			400	mΩ
		V <sub>GS</sub> =1.8V, I <sub>D</sub> =200mA			700	mΩ
Diode Forward Voltage <sup>(Note4)</sup>	V <sub>SD</sub>	V <sub>GS</sub> =0V, I <sub>S</sub> =500mA			1.2	V
<b>Dynamic Characteristics<sup>(Note5,6)</sup></b>						
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =16V, V <sub>GS</sub> =0V, f=1MHz		33		pF
Output Capacitance	C <sub>oss</sub>			20		
Reverse Transfer Capacitance	C <sub>rss</sub>			10		
Total Gate Charge	Q <sub>g</sub>	V <sub>GS</sub> =4.5V, V <sub>DS</sub> =10V, I <sub>D</sub> =1A		800		pC
Gate-Source Charge	Q <sub>gs</sub>			290		
Gate-Drain Charge	Q <sub>gd</sub>			160		
Turn-On Delay Time	t <sub>d(on)</sub>	V <sub>GS</sub> =4.5V, V <sub>DS</sub> =10V, IDS=0.5A, R <sub>G</sub> =10Ω		4		ns
Turn-On Rise Time	t <sub>r</sub>			18		
Turn-Off Delay Time	t <sub>d(off)</sub>			11.6		
Turn-Off Fall Time	t <sub>f</sub>			24		

Note 4. Pulse Test : Pulse Width≤300μs, Duty Cycle ≤ 2%.

5. Switching characteristics are independent of operating junction temperature.

6. Guaranteed by Design, Not Subject to Production Testing.

## Curve Characteristics

Fig. 1 - Output Characteristics

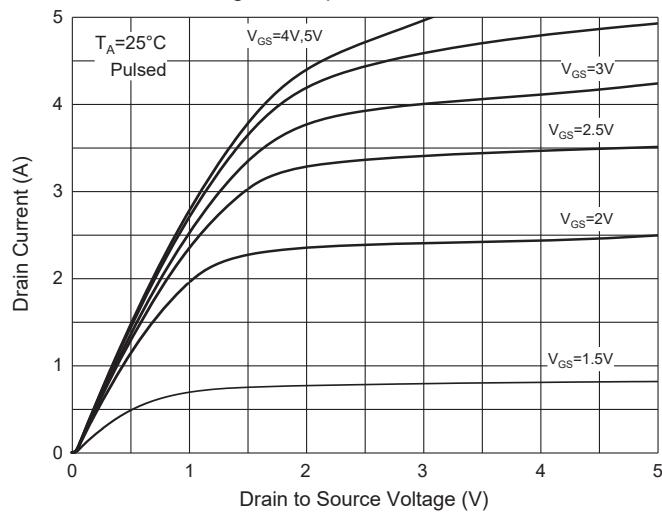


Fig. 2 - Transfer Characteristics

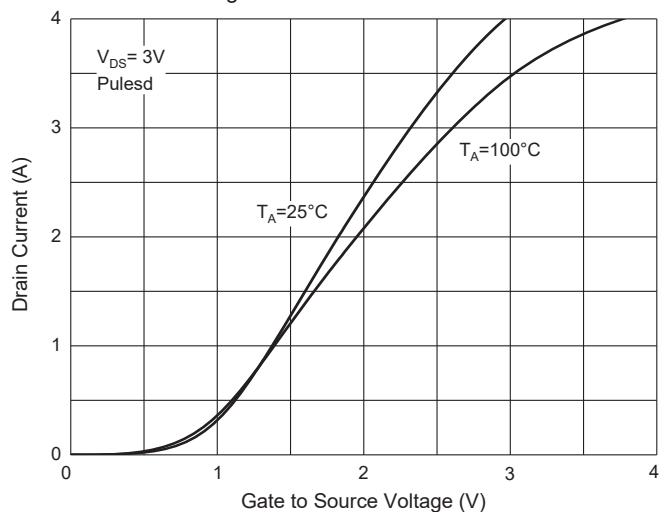


Fig. 3 - R<sub>DS(ON)</sub>—I<sub>D</sub>

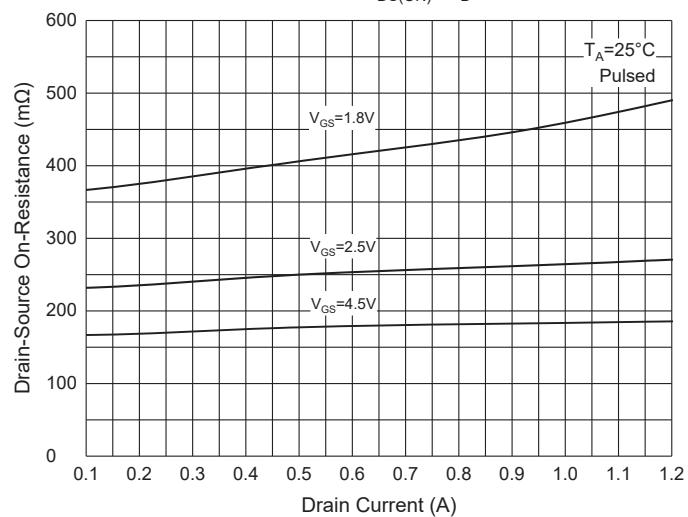


Fig. 4 - Threshold Voltage

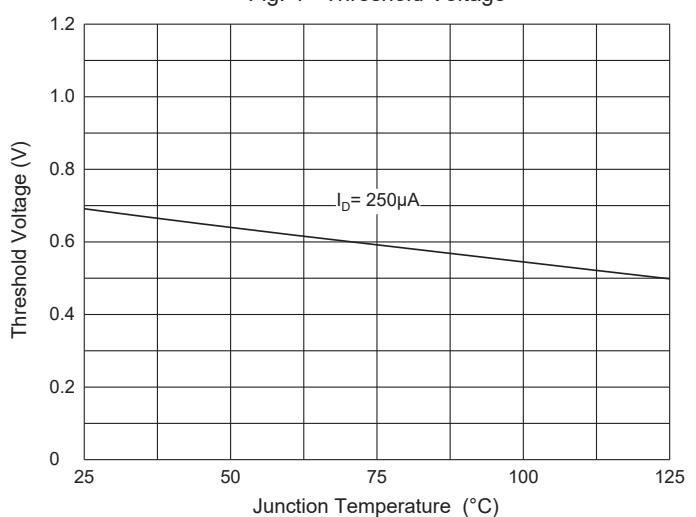


Fig. 5 - Gate Charge

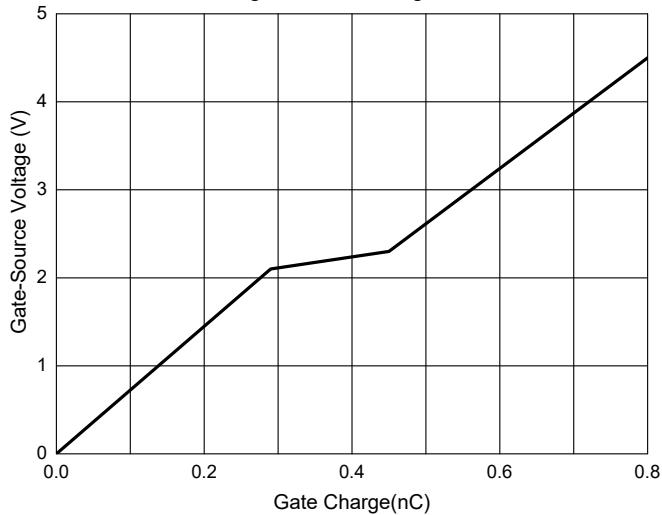
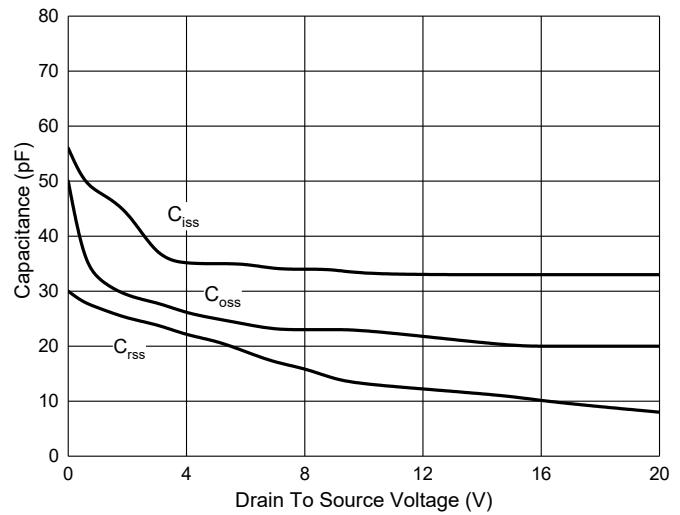


Fig. 6 - Capacitance Characteristics



## Ordering Information

Device	Packing
Part Number-TP	Tape&Reel:3Kpcs/Reel

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